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Substitute for form 1449APTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use as many sheets as necessary)	Complete if Known			
	Application Number	Unknown 10165619		
	Filing Date	Even Date Herewith		
	First Nam d Inventor	Ahn, Kie		
	Group Art Unit	Unknown		
	Examiner Name	Unknown		
Sheet 1 of 3	Attorney Docket No: 1	1303.033US2		

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	First Named Inventor	Ahn, Kie	
	Group Art Unit	Unknown	
	Examiner Name	Unknown	
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	Group Art Unit	Unknown		
	Examiner Name	Unknown		
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